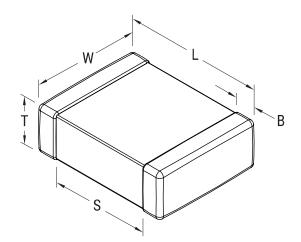


## C0603X100M2TAC7411

SMD Comm X8G HT150C Flex, Ceramic, 10 pF, 20%, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	4.6 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
	Capacitance	10 pF
	Measurement Condition	1 MHz 1.0Vrms
	Tolerance	20%
	Voltage DC	200 VDC
	Dielectric Withstanding Voltage	500 VDC
	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
	Insulation Resistance	100 GOhms

 Dimensions

 Chip Size
 0603

 L
 1.6mm +/-0.17mm

 W
 0.8mm +/-0.15mm

 T
 0.8mm +/-0.15mm

 S
 0.4mm MIN

 B
 0.45mm +/-0.15mm

## Packaging Specifications Packaging Television Packaging Quantity 15

T&R, 330mm, Paper Tape 15000

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